# First space application of Monolithic Active Pixel Sensors for particle tracking: the High Energy Particle Detector onboard the CSES-02 satellite

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# Summary

- The CSES-02 satellite and the High-Energy Particle Detector (HEPD-02).
- The ALPIDE Monolithic Active Pixel Sensor (MAPS) in HEPD-02 tracker.
- ALPIDE tracker design and space-application compliance.
- ALPIDE performances in HEPD-02.
- Control and read-out electronics for HEPD-02 tracker.

CSES-02 satellite

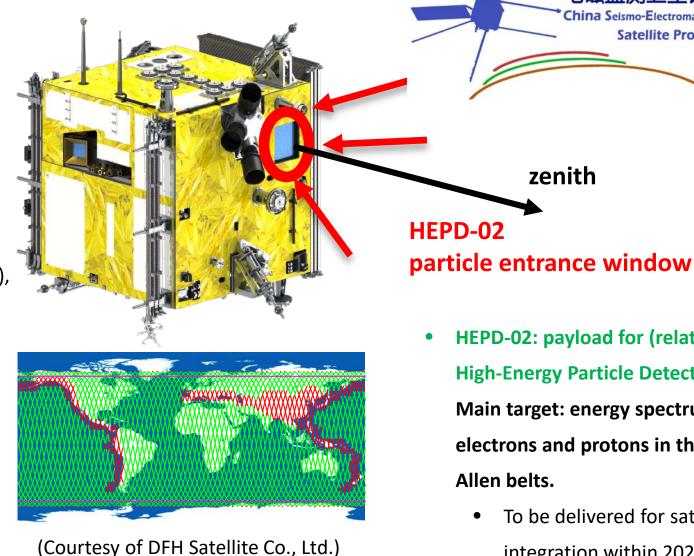
**CSES-02: China Seismo-Electromagnetic** Satellite.

Total Mass: 900 kg

**Orbit:**  $-65^{\circ}$  to  $+65^{\circ}$  latitude, 500 km, sun-synchronous.

> • Same as CSES-01 (launched in Feb 2018), with 180° phase difference.

- Orbit maneuver capability.
- Earth-oriented stabilization system.
- Design life cycle > 6 years.
- **Equipped with several payloads for** electromagnetic and plasma measurements in the Van Allen belts.



**HEPD-02:** payload for (relatively) **High-Energy Particle Detection.** Main target: energy spectrum of

zenith

electrons and protons in the Van Allen belts.

China Seismo-Electromagnetic

**Satellite Program** 

To be delivered for satellite integration within 2022.

#### HEPD-02

### **Particles** zenith √ depth: 40 cm Lateral Veto (4×) Trigger 1 (T1) 20 cm Tracker Trigger 2 (T2) Internal Calorimeter

- The tracker (3 MAPS layers) follows the first thin layer of trigger scintillators.
- Amount of materials on top and inside the tracker has been minimized to reduce multiple scattering.

Kin. energy range (electron)	3 MeV to 100 MeV	
Kin. energy range (proton)	30 MeV to 200 MeV	
Angular resolution	≤10° for E <sub>kin</sub> > 3 MeV electrons	
<b>Energy resolution</b>	≤10% for E <sub>kin</sub> > 5 MeV electrons	
Particle selection efficiency	> 90%	
Detectable flux	up to 10 <sup>7</sup> m <sup>-2</sup> s <sup>-1</sup> sr <sup>-1</sup>	
Operating temperature	-10 °C to +35 °C	
Operating pressure	≤ 6.65 · 10 <sup>-3</sup> Pa ("vacuum")	
Mass budget	50 kg	
Power Budget	45 W	
Data budget	≤ 100 Gb/day	

#### From HEPD-01 to HEPD-02 tracker

# HEPD-01 tracker (on-board of CSES-01 satellite) employs Si microstrip sensors (50 µm resolution).

- Technology developed for vertexing and momentum measurement.
- Traditional technology for tracking particles in space.
- Well-known assembly designs for space compliance.

#### Some disadvantages:

- custom-made technology;
- sensor and analog read-out circuit are separately manufactured and bonded together;
- possible multiple-track hits on the same strip.

# HEPD-02 tracker will employ ALPIDE Monolithic Active Pixel Sensor (MAPS).

- Binary pixel response.
- Sensor and read-out circuit on the same Si substrate (difference with respect to hybrid pixel sensors).

#### Some advantages:

- compact assembly;
- low noise;
- spacial resolution (for Z=1 MIP): 5 μm.

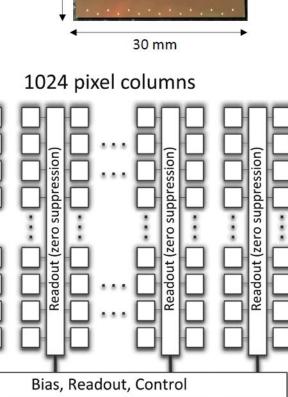
#### **Several challenges:**

- relatively new technology, not build for use in space;
- assembly must be stiff for expected structural stresses;
- assembly must sustain repeated thermal cycles in vacuum;
- power consumption must reduced to comply with budget;
- requires characterization for use with low-energy protons and ions.

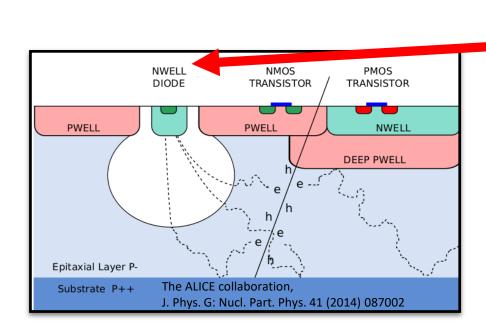
#### The ALPIDE MAPS in HEPD-02 tracker

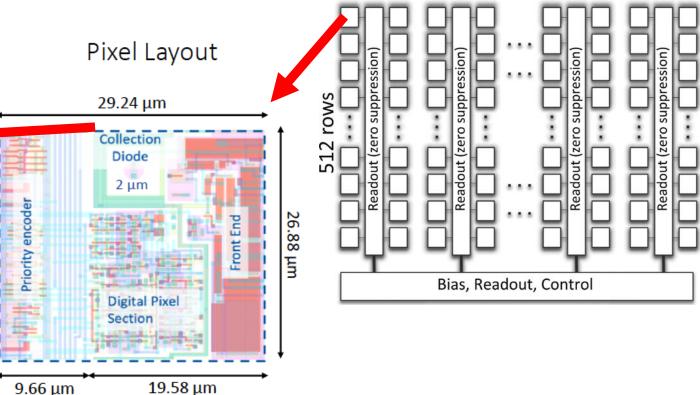
- Inner Tracker (ITS) upgrade at LHC accelerator (CERN).
- ALPIDE: **512** x **1024** pixels in 15 x 30 mm<sup>2</sup>.
  - Available thickness 100 or **50 μm.**
  - Back-bias up to -6 V.
  - Charge collection by diffusion.
  - Low noise (~10 e / pixel).

- ALPIDE MAPS was designed for ALICE Threshold readout circuit (binary output): 180 nm CMOS technology.
  - Deep p-well allows for **PMOS transistor** collection efficiency.
  - implantation on chip without reducing Fully zero-suppressed digital output.



mm





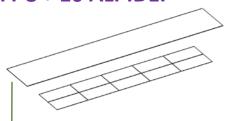
## Space compliance: main items

- Use of MAPS is unprecedented in space, thus the tracker design requires R&D for:
  - (1) adequate assembly stiffness to sustain structural stresses during launch, orbital maneuvers and demanding qualification tests required by Space Agencies (> 10 G accelerations);
  - (2) appropriate thermal drain by pure conduction toward external Al-alloy support frame ("vacuum" condition means absence of air convection);
  - (3) endurance over repeated thermal cycling and operation in vacuum between -30°C and +50 °C temperature of HEPD-02 mechanical frame;
  - (4) keeping the **power budget** within strict limits imposed by satellite application (**~13 W** available for the whole tracker).

- (1) and (2) go against HEPD-02 scientific requirements of low-density / low-thickness support materials along the incoming particle direction:
  - to minimize multiple scattering;
  - to minimize the energy loss in passive layers.
- This is especially important for electrons in the lower part of the kinetic energy range of interest (down to 3 MeV).
- (4) goes against fast event processing and data transmission.
- The tracker design has therefore been driven to possibly find the best achievable compromise between scientific and technological requirements.

### HEPD-02 tracker design: HIC and stave

(I) HIC (Hybrid Integrated Circuit): FPC + 10 ALPIDE.



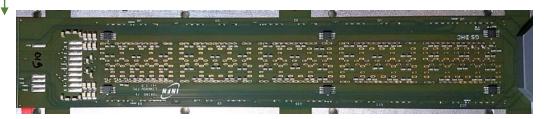
(II) End Blocks + Cold Plate



kapton + copper tracks for signal and power routing to chips.

FPC/ALPIDE glued and connected via triple-redundancy bondings.





(III) Stave: HIC glued to Cold Plate.



- End Blocks (Al alloy) for fixing to support frame.
- Cold Plate (CFRP: carbon fibre + epoxy resin) with optimized structural/thermal design, glued to End Blocks via high-performance glue.

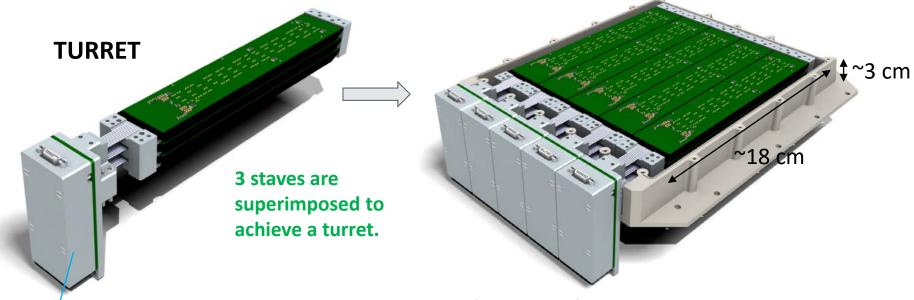
This assembly gives:

- stiffness against structural stresses;
- endurance over thermal cycling;
- thermal drain from ALPIDE chips toward support frame, with gradient along Cold Plate kept within 6° C, when all ALPIDE chips are fully active.

For more details see **poster by E. Serra**:

https://indico.cern.ch/event/981823/contributions/4295441/

## HEPD-02 tracker design: turrets



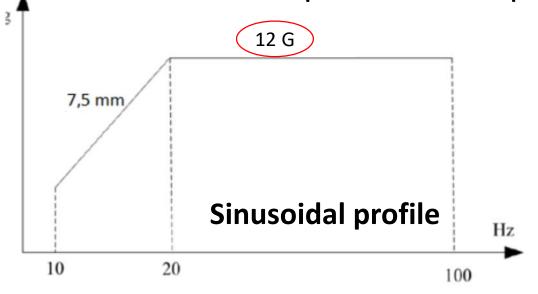
The whole tracker is formed by 5 turrets.

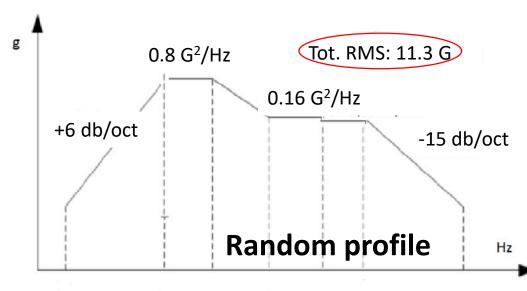
- 15 staves;
- 150 ALPIDE;
- ~ 80 Mpixel in 3 planes.

- The first set of staves have been assembled.
- A first prototype turret has been assembled.
- Space compliance verification tests are ongoing.
- First complete tracker to be assembled in few months, for integration in HEPD-02 qualification model.
- See also poster by L. de Cilladi: https://indico.cern.ch/event/981823/contributions/4295446/

TSP (Tracker SPlitter) board for cabled interface with power and control/read-out electronics.
TSP connected to the staves via soldered wires (few cm length).

## Space compliance: vibration tests





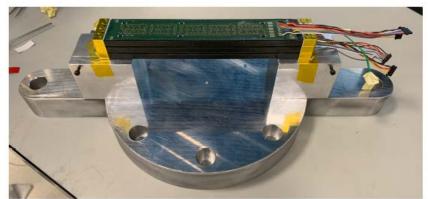
600

2000

- Vibration tests performed on a prototype turret at SERMS, Terni (IT).
  - Stress profiles applied (on each axis) to take into account extreme vibration profiles, much worser than expected at launch (as required by Space Agencies).
  - Control accelerometers located on the turret (bottom Cold Plate) and on the fixture.

#### The test was successful:

- verified first resonance mode >800 Hz (>> 100 Hz required);
- no mechanical anomalies detected on the assembly (gluings, bondings, solderings etc.);
- detector performances not affected.



## Space compliance: thermo-vacuum test

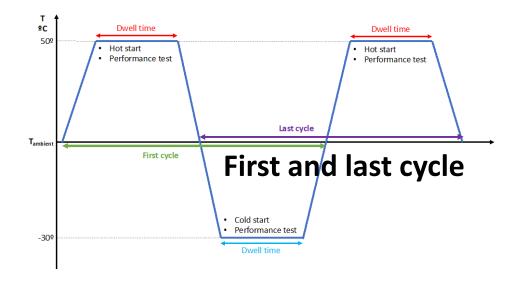
#### Thermo-vacuum cycle tests performed on a HIC.

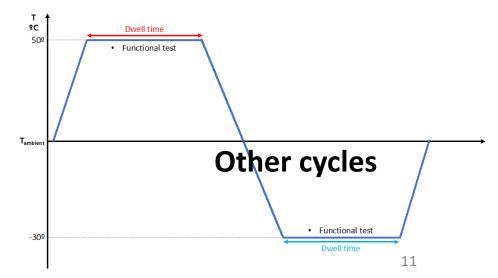
- Test designed to apply thermal stresses in "vacuum", much worser than expected during the flight (as required by Space Agencies).
- Detector performances monitored at low and high cycle temperatures (thermal dwell).

#### The test was successful for HIC:

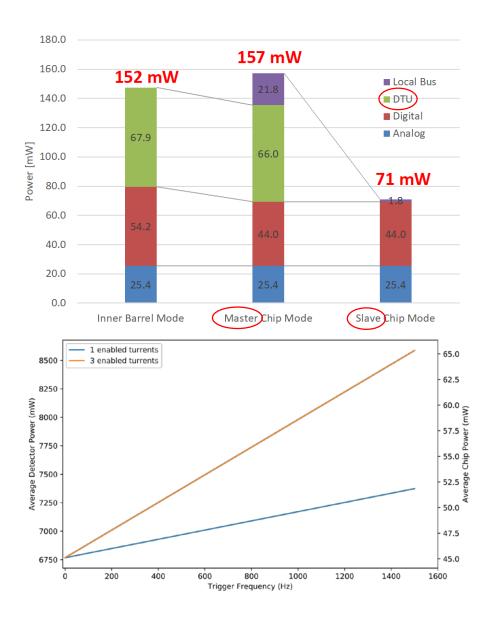
- no mechanical anomalies detected on the assembly (gluings, bondings etc.) after the cycles;
- detector performances not affected both during and after the cycles.

Parameter	Test conditions
Pressure [Pa]	<6.66 · 10 <sup>-3</sup>
Hot temperature at fixture [°C]	+50
Cold temperature at fixture [°C]	-30
Number of cycles	6.5
Temperature rate of change [°C/min]	≥1
Dwell time [h]	≥2





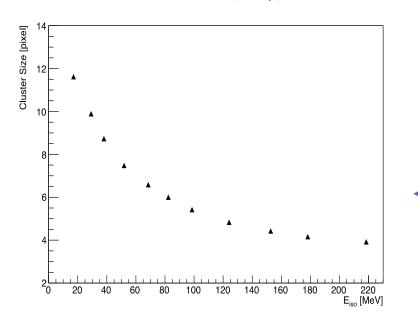
## Space compliance: power consumption mitigation

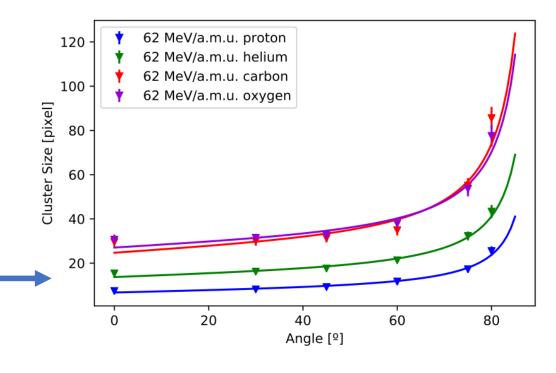


- Several changes of configuration implemented with respect to application in ALICE (CERN), to comply with strict power limitation on satellite (~13 W available for the whole tracker).
  - Master-slave architecture (1 master out of 5 chips)
     with sequential slave read-out through master.
  - Permanent switch-off of fast data transmission unit (DTU) and read-out through serial slow-control line.
    - Acceptable increase of dead time, given the relatively low trigger rate sustainable by the HEPD-02 system (up to few kHz).
  - Clock gating: ALPIDE clock normally off, set on with trigger:
    - trigger: clock on (17 mW/cm²);
    - wait for signal digitization;
    - transmit data to control/read-out electronics;
    - clock off (7 mW/cm<sup>2</sup>): wait for new trigger.

## ALPIDE response to low-energy ions

- ALPIDE designed and widely characterized for Z=1 MIP detection, for application in ALICE at LHC (CERN).
  - Main observable: cluster size i.e. number of pixels with signal > threshold (binary output 1).
  - For Z=1 MIP, cluster size is  $\leq$  4 pixel.
- In view of HEPD-02 application, ALPIDE response has been tested for low-energy ions with different incoming directions.
  - Protons at Trento Proton Therapy Centre, Trento (Italy).
  - Nuclei at LNS, Catania (Italy).



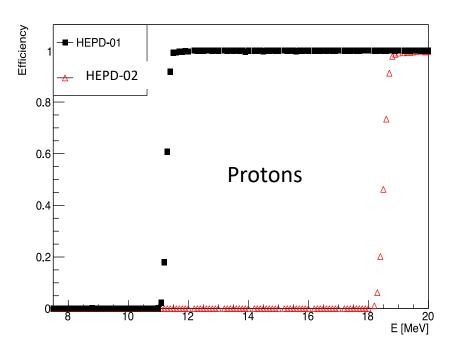


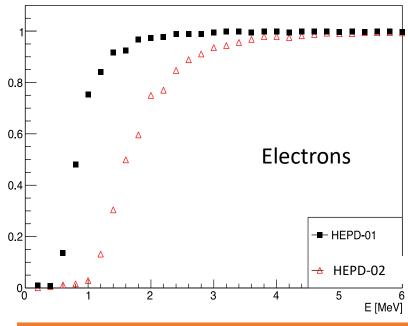
- Having a binary threshold readout, ALPIDE can not be used for measurement of deposited energy (dE/dx).
- An interesting dependence of typical cluster size from kinetic energy of the incident particle was measured for low-energy protons and nuclei.

# Energy threshold for particle detection

Comparison between HEPD-01 microstrip tracker and HEPD-02 ALPIDE tracker:

 energy threshold for particle detection (i.e. for all planes, the signal is over the noise-rejection threshold set).





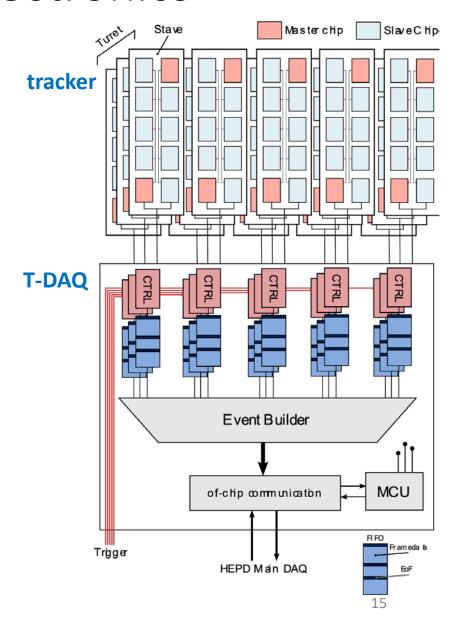
Detection threshold of HEPD-02 tracker is higher than HEPD-01 tracker (but still compatible with requirements) because:

- number of detector planes has been increased from 2 to 3 to obtain redundancy of track sampling thus improving tracking quality;
- there is a major contribution to energy loss from FPC copper tracks and CFRP Cold Plate, while the Si thickness has been reduced by 6 times (from 300 μm microstrip sensor to 50 μm ALPIDE).

Stave element	Material	Thickn. [μm]	Rad. length X <sub>0</sub> [%]
FPC board	Kapton	135	0.048
FPC tracks	Cu	36	0.251
Glue	Araldite 2011	130	0.029
ALPIDE	Si	50	0.053
Cold plate	Carbon fibre + epoxy resin	350	0.134
TOTAL			0.515

#### Control and read-out electronics

- Fully customized for HEPD-02 space application.
  - Compactness: whole tracker control and read-out in a single board (T-DAQ).
  - Design driven by power consumption limits (3 W budget for T-DAQ).
  - Hot/cold redundancy (i.e. two identical copies of the circuit in the same board) to increase overall reliability during flight.
- Control logics and Microblaze soft processor implemented on Xilinx Artix 7 FPGA.
- 15 CTRL logic modules (one per stave) handle the full ALPIDE housekeeping and data acquisition through serial bidirectional line.
  - Tracker segmentation (and superposition of an independent trigger bar to each turret in HEPD-02 layout) allow to read-out a subset of the 5 turrets (or 2 planes only), if required to reduce power or dead time.
- The soft processor implements calibration and service procedures (switched-off most of time to save power).
  - Threshold calibration procedure identifies and excludes dead/noisy pixels.



#### Conclusions

- HEPD-02 ALPIDE tracker will be the first ever use of MAPS in a space application.
- HEPD-02 tracker design is a compromise between scientific target and demanding space compliance requirements.
- Several space compliance tests successfully performed. More to come.
- Basic ALPIDE performances in HEPD-02 studied. More studies to come.
- Tracker modules (staves) currently undergoing production.
- Integration in HEPD-02 flight model scheduled within 2022.